SN74LVCHR16245A供应商

 Member of the Texas Instruments Widebus™ Family 	DGG OR DL PACKAGE (TOP VIEW)
 EPIC[™] (Enhanced-Performance Implanted CMOS) Submicron Process 	
 Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C 	1B1 0 2 47 0 1A1 1B2 0 3 46 0 1A2 GND 0 4 45 0 GND
 Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at V_{CC} = 3.3 V, T_A = 25°C 	1B3 5 44 1A3 1B4 6 43 1A4
 Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC}) 	V _{CC} 7 42 V _{CC} 1B5 8 41 1A5
 Power Off Disables Inputs/Outputs, Permitting Live Insertion 	1B6 0 9 40 1A6 GND 10 39 GND 1B7 11 38 1A7
 ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0) 	1B8 0 12 37 0 1A8 2B1 0 13 36 0 2A1 2B2 0 14 35 0 2A2
 Latch-Up Performance Exceeds 250 mA Per JESD 17 	GND [15 34] GND 2B3 [16 33] 2A3
 Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors 	2B4 117 32 2A4 V _{CC} 18 31 V _{CC} 2B5 19 30 2A5 2B6 20 29 2A6
 All Outputs Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required 	GND [21 28] GND 2B7 [22 27] 2A7 2B8 [23 26] 2A8
 Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink 	2DIR 24 25 20E

Small-Outline (DGG) Packages

NOTE: For order entry:

The DGG package is abbreviated to G.

For tape and reel: The DGGR package is abbreviated to GR, and the DLR package is abbreviated to LR.

description

This 16-bit (dual-octal) noninverting bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVCHR16245A is designed for asynchronous communication between data buses. The control-function implementation minimizes external-timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can disable the device so that the buses are effectively isolated.

All outputs, which are designed to sink up to 12 mA, include equivalent 26- Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



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description (continued)

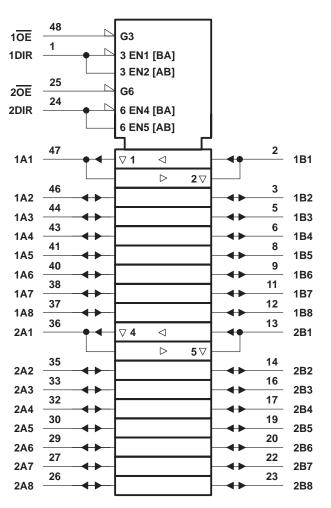
Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCHR16245A is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each 8-bit section)						
INPUTS						
OPERATION						
L L B data to A bus						
Н	A data to B bus					
H X Isolation						
	(each 8- UTS DIR L H					

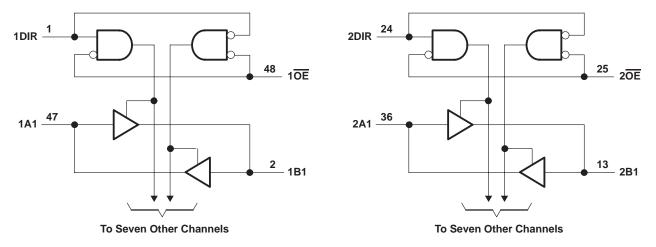
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	
Input voltage range, V _I (see Note 1)	0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V_{O}	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V _O	
(see Notes 1 and 2)	–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, I _O	
Continuous current through each V _{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	
DL package	
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of V_{CC} is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.



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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vee	Supply voltage	Operating	1.65	3.6	V	
Vcc	Supply voltage	Data retention only	1.5		v	
	High-level input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$			
VIH		put voltage $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$				
		V _{CC} = 2.7 V to 3.6 V	2			
		V _{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	1	
VIL	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		V _{CC} = 2.7 V to 3.6 V		0.8		
VI	Input voltage		0	5.5	V	
VO	Output voltage	High or low state	0	VCC	v	
		3-state	0	5.5	V	
	High-level output current	V _{CC} = 1.65 V		-2	4 mA	
1		V _{CC} = 2.3 V		-4		
ЮН		$V_{CC} = 2.7 V$		-8		
		$V_{CC} = 3 V$		-12		
		V _{CC} = 1.65 V		2		
1	Low-level output current	V _{CC} = 2.3 V		4		
IOL		V _{CC} = 2.7 V		8	mA	
		$V_{CC} = 3 V$		12	1	
$\Delta t/\Delta v$	Input transition rise or fall rate	·		10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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PAF	AMETER			Vcc	MIN	түр†	MAX	UNIT
I Voh		I _{OH} = −100 μA		1.65 V to 3.6 V	V _{CC} -0.2	2		
		I _{OH} = -2 mA		1.65 V	1.2			
		1	2.3 V	1.7			V	
		$I_{OH} = -4 \text{ mA}$	2.7 V	2.2				
		IOH =6 mA		3 V	2.4			
		I _{OH} = -8 mA		2.7 V	2			
		I _{OH} = -12 mA		3 V	2			
		I _{OL} = 100 μA		1.65 V to 3.6 V			0.2	
		I _{OL} = 2 mA		1.65 V			0.45	
		1		2.3 V			0.7	
VOL		IOL = 4 MA	I _{OL} = 4 mA				0.4	V
		IOL = 6 mA	3 V			0.55		
		IOL = 8 mA	2.7 V			0.6		
		I _{OL} = 12 mA	3 V			0.8		
Ц	Control inputs	V _I = 0 to 5.5 V		3.6 V			±5	μΑ
		VI = 0.58 V	1 GE V	‡				
		V _I = 1.07 V	1.65 V	‡				
		V _I = 0.7 V	2.2.1/	45				
II(hold)	A or B ports	VI = 1.7 V	2.3 V	-45			μA	
		VI = 0.8 V						
	V _I = 2 V			3 V	-75			
	$V_{I} = 0 \text{ to } 3.6 \text{ V}$			36 V			±500	
l _{off}		$V_I \text{ or } V_O = 5.5 \text{ V}$	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}$				±10	μA
loz¶	V_{OZ} V $_{O} = 0$ to 5.5 V		3.6 V			±10	μΑ	
ICC		V _I = V _{CC} or GND,		0.01/			20	٥
		$3.6 \text{ V} \le \text{V}_{I} \le 5.5 \text{ V}^{\#}$	I ^O = 0	3.6 V			20	μA
Δlcc		One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND		2.7 V to 3.6 V			500	μA
Ci	Control inputs	$V_{I} = V_{CC} \text{ or } GND$		3.3 V		3		pF
Cio	A or B ports	$V_{O} = V_{CC}$ or GND				12		pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] All typical values are at $V_{CC} = 3.3$ V, $T_A = 25^{\circ}C$.

[‡] This information was not available at the time of publication.

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

¶ For I/O ports, the parameter I_{OZ} includes the input leakage current, but not $I_{I(hold)}$.

[#] This applies in the disabled state only.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = ± 0.1		V _{CC} = ± 0.2		V _{CC} =	2.7 V	= ۷ _{CC} ± 0.3	3.3 V 3 V	UNIT
		(001-01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	A or B	B or A	‡	‡	‡	‡		5.7	1.5	4.8	ns
t _{en}	OE	A or B	‡	‡	‡	‡		7.9	1.5	6.3	ns
^t dis	OE	A or B	‡	‡	‡	‡		8.3	2.2	7.4	ns

[‡] This information was not available at the time of publication.

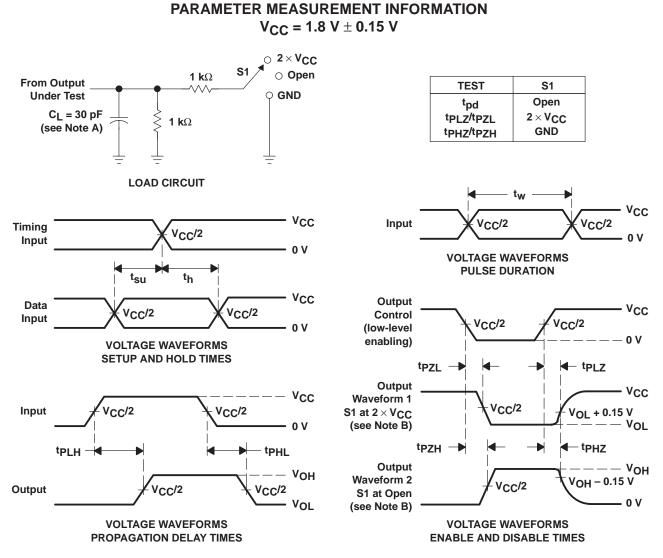
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operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	V _{CC} = 1.8 V TYP	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT	
Cpd	Power dissipation capacitance	Outputs enabled	£ 10 MU	†	†	39	рF
Cpd	per transceiver	Outputs disabled	f = 10 MHz	†	†	4	μr

[†] This information was not available at the time of publication.





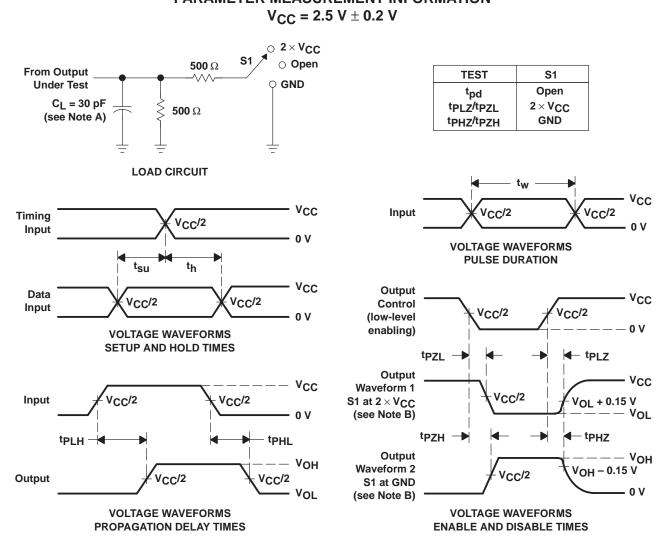
- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_f ≤ 2 ns, t_f ≤ 2 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - D. The outputs are measured one at a time with one trans
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. tpzL and tpzH are the same as ten.
 - G. tPLH and tPHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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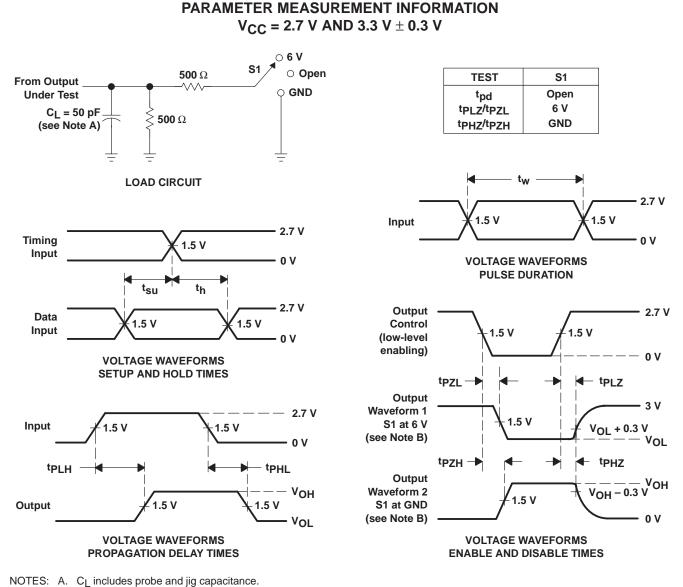


- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2 ns, t_f \leq 2 ns.

 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. tpzL and tpzH are the same as ten.
 - G. tpl H and tpHI are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms





- - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 0 MHz, Z_O = 50 Ω , t_f ≤ 2.5 ns. t_f ≤ 2.5 ns. D. The outputs are measured one at a time with one transition per measurement.

 - E. tpLz and tpHz are the same as tdis.
 - F. tPZL and tPZH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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